

FIG.1A

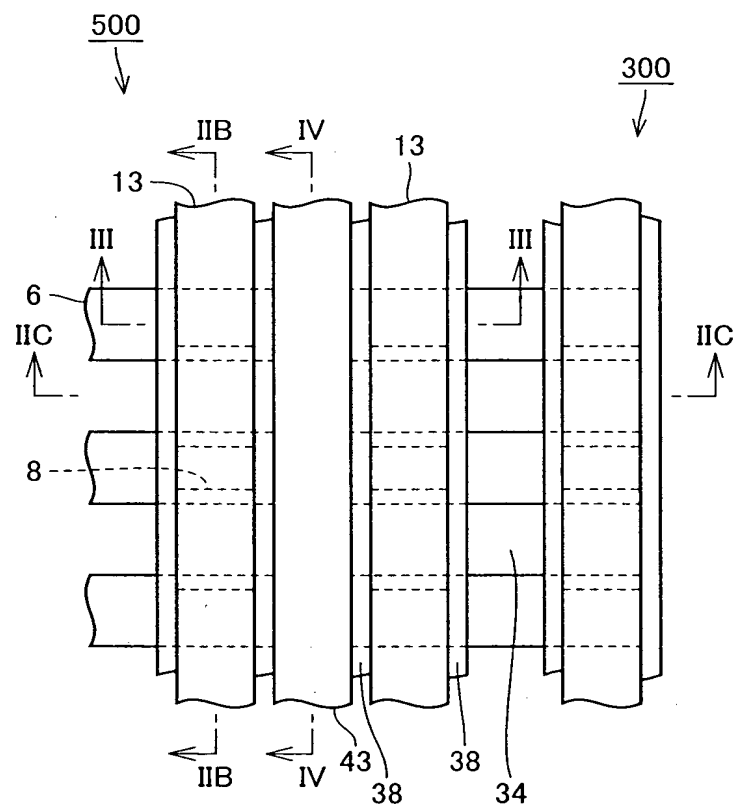


FIG.1B

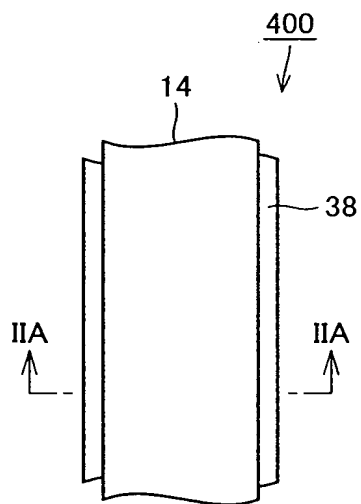


FIG.2A

FIG.2B

FIG.2C

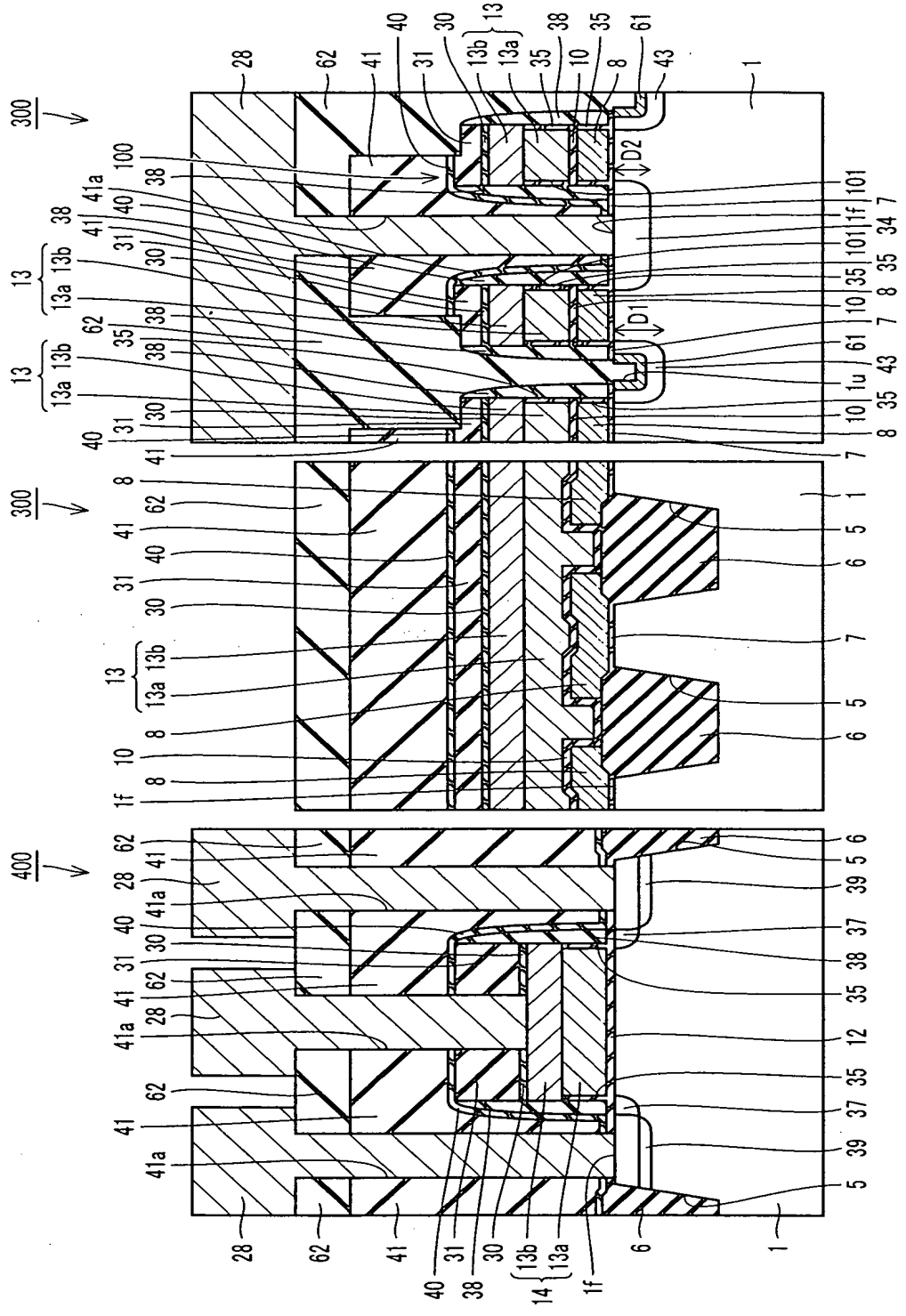


FIG.3

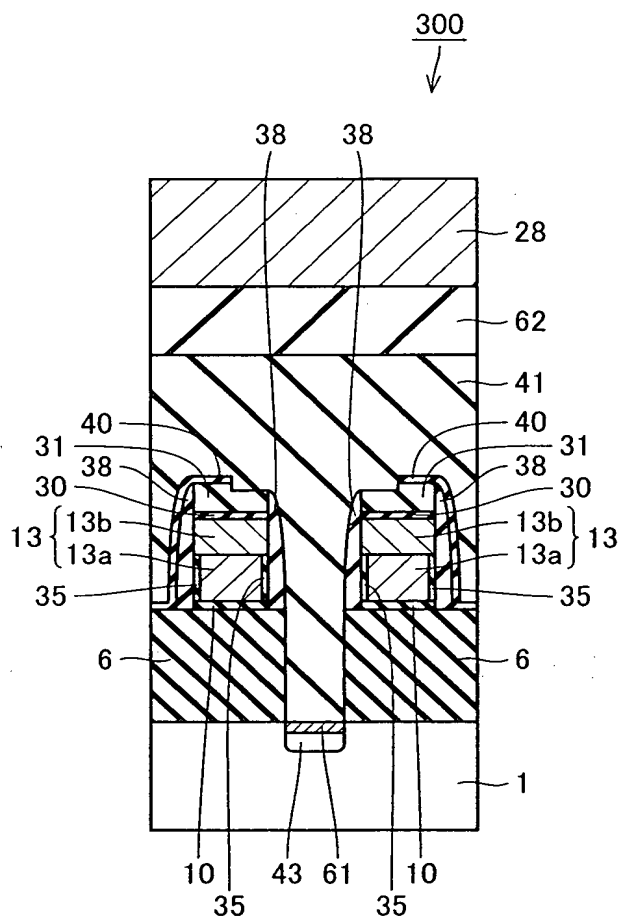


FIG.4

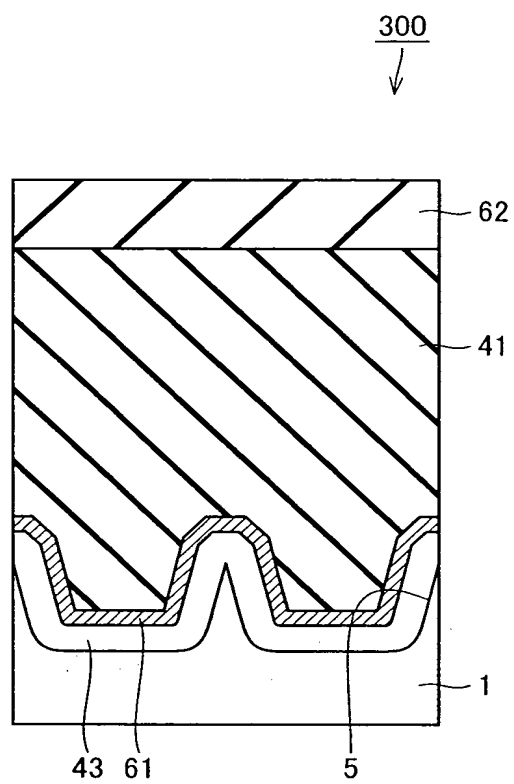


FIG.5A

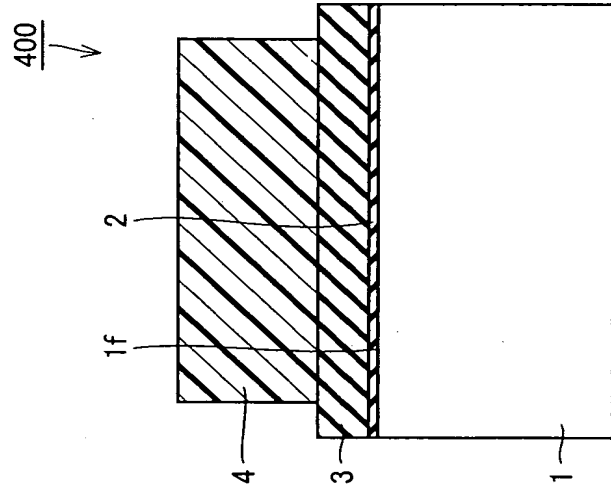


FIG.5B

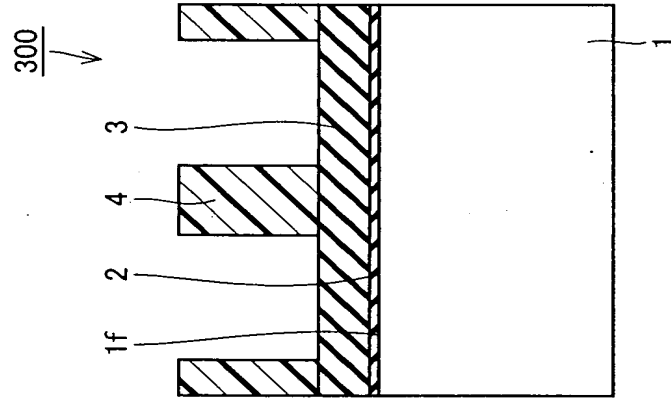


FIG.5C

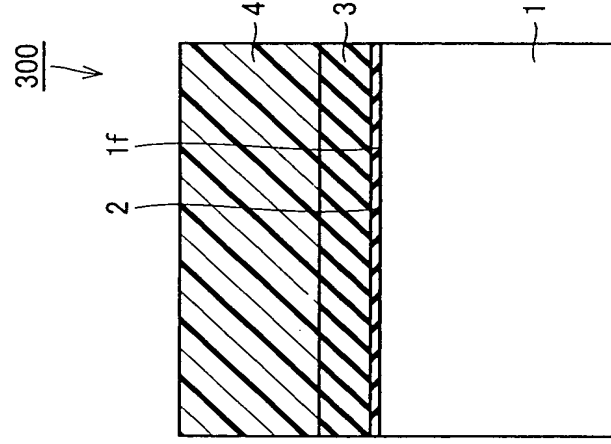


FIG.6A

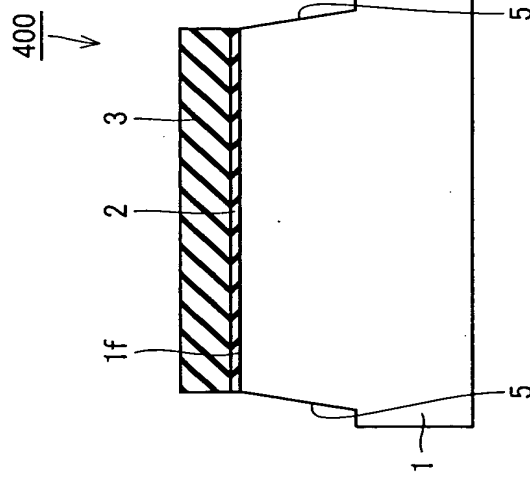


FIG.6B

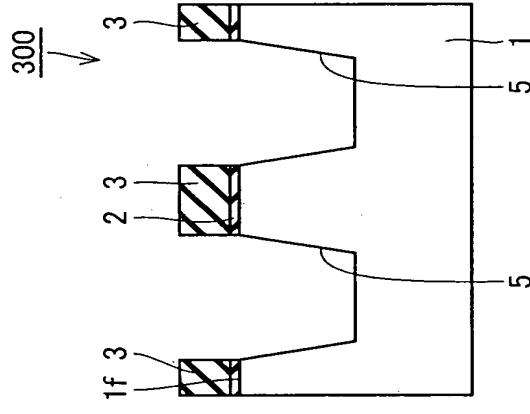


FIG.6C

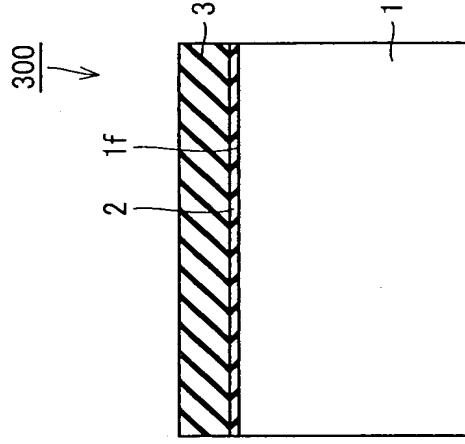


FIG.7A

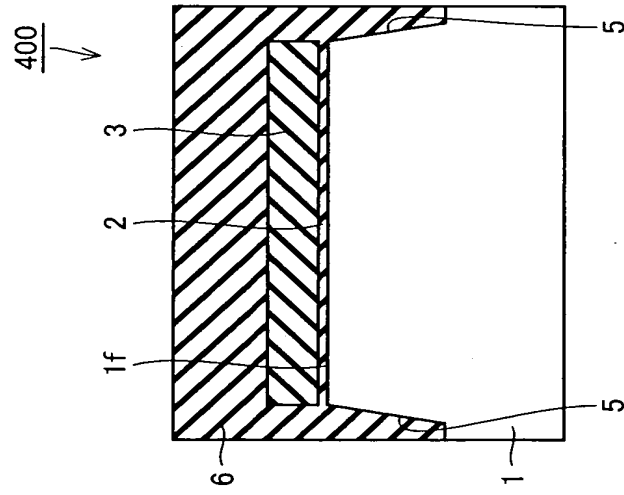


FIG.7B

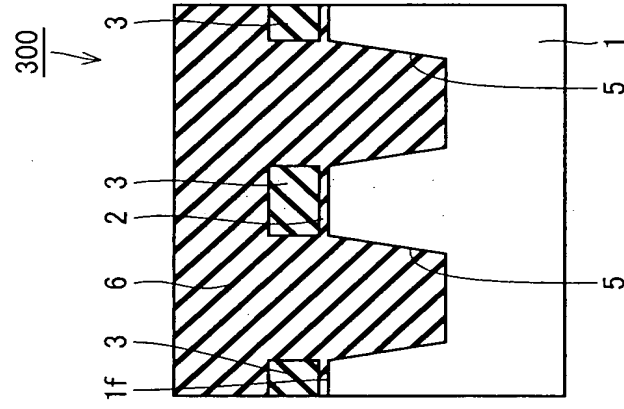


FIG.7C

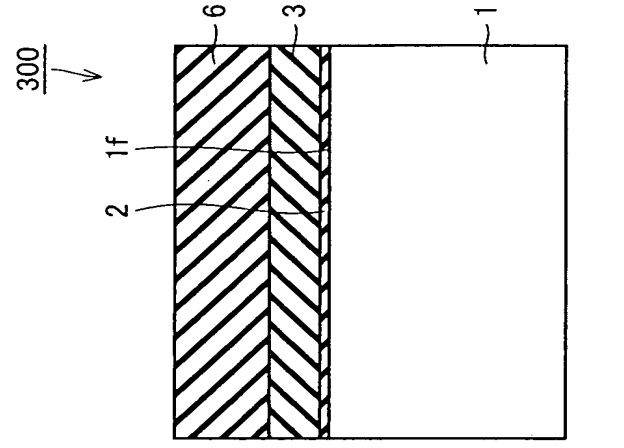


FIG.8A

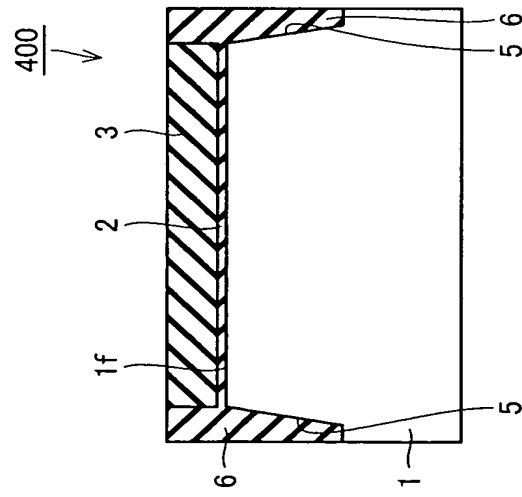


FIG.8B

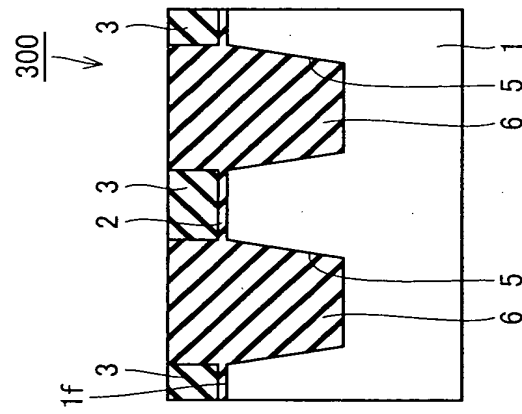


FIG.8C

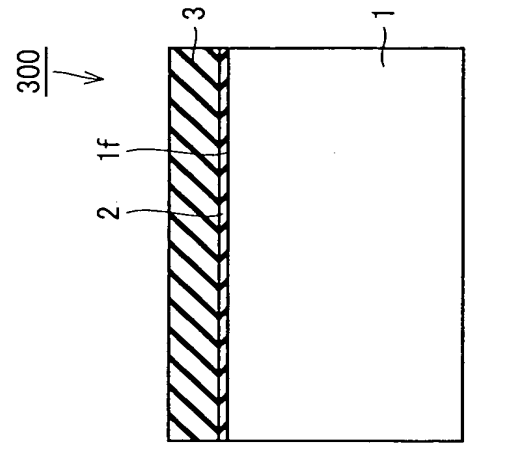


FIG.9A

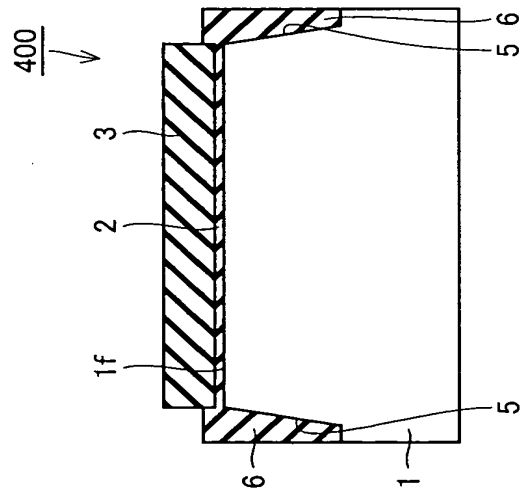


FIG.9B

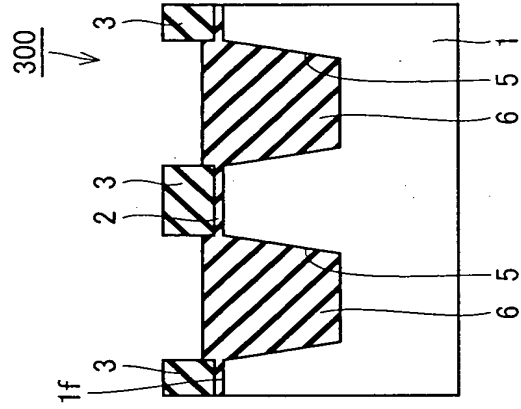


FIG.9C

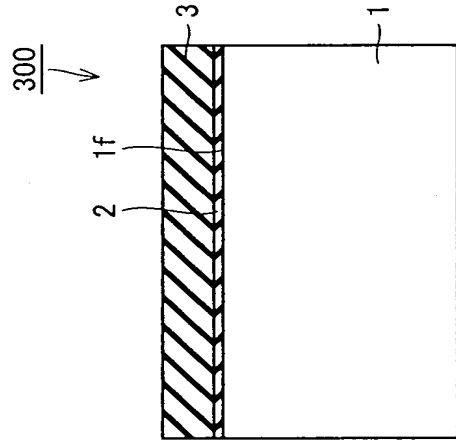


FIG.10A

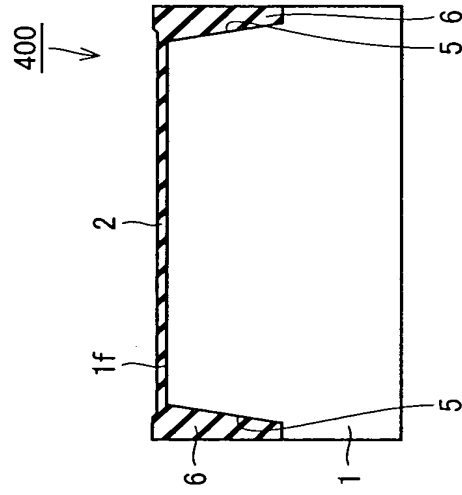


FIG.10B

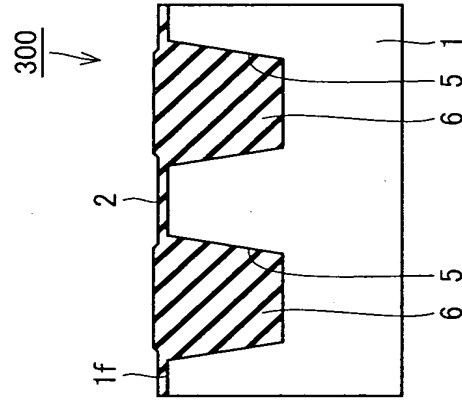


FIG.10C

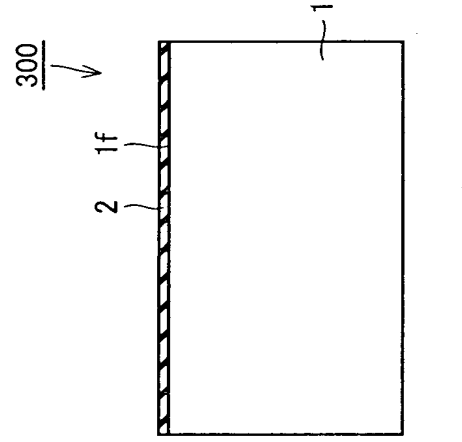


FIG. 11A

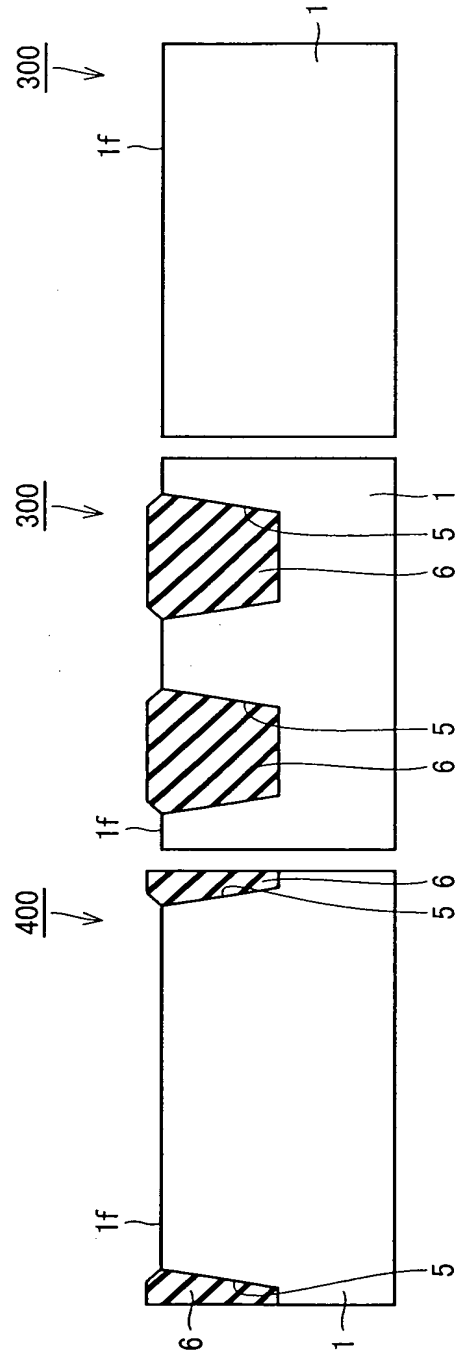


FIG. 11B

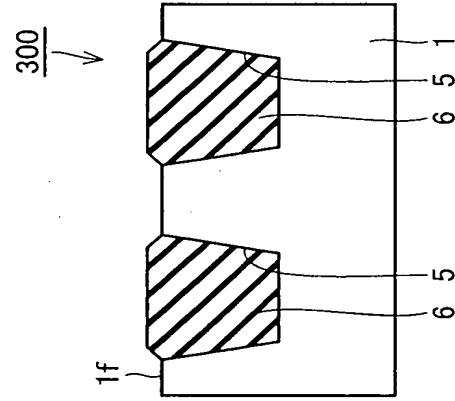


FIG. 11C

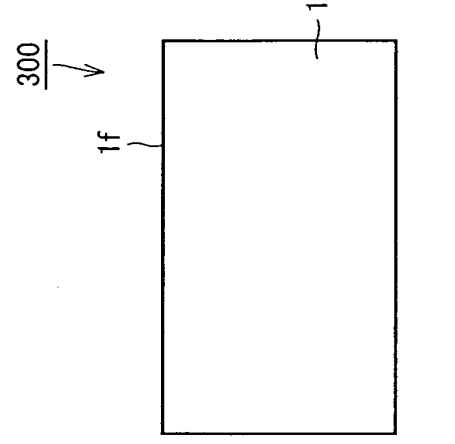


FIG.12A

400
↓

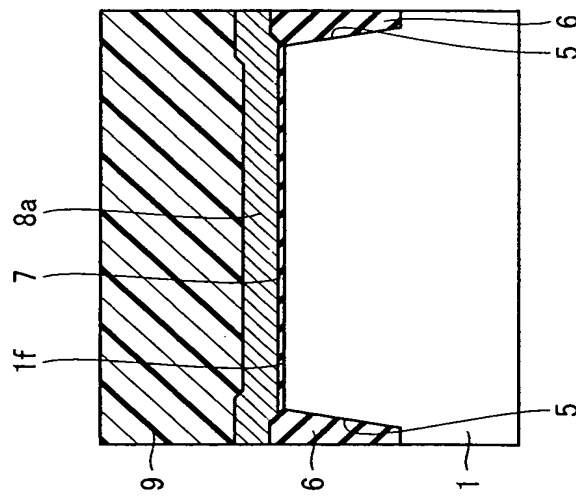


FIG.12B

300
↓

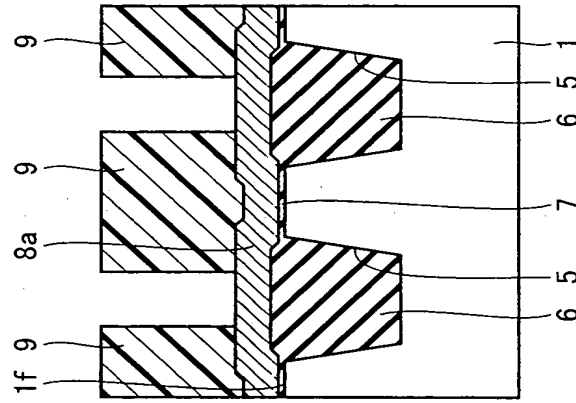


FIG.12C

300
↓

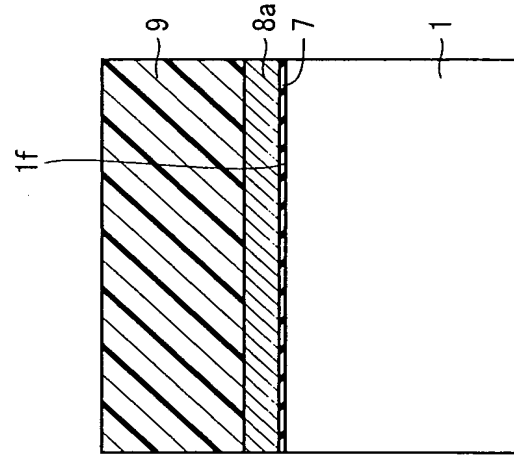


FIG.13A

FIG.13B

FIG.13C

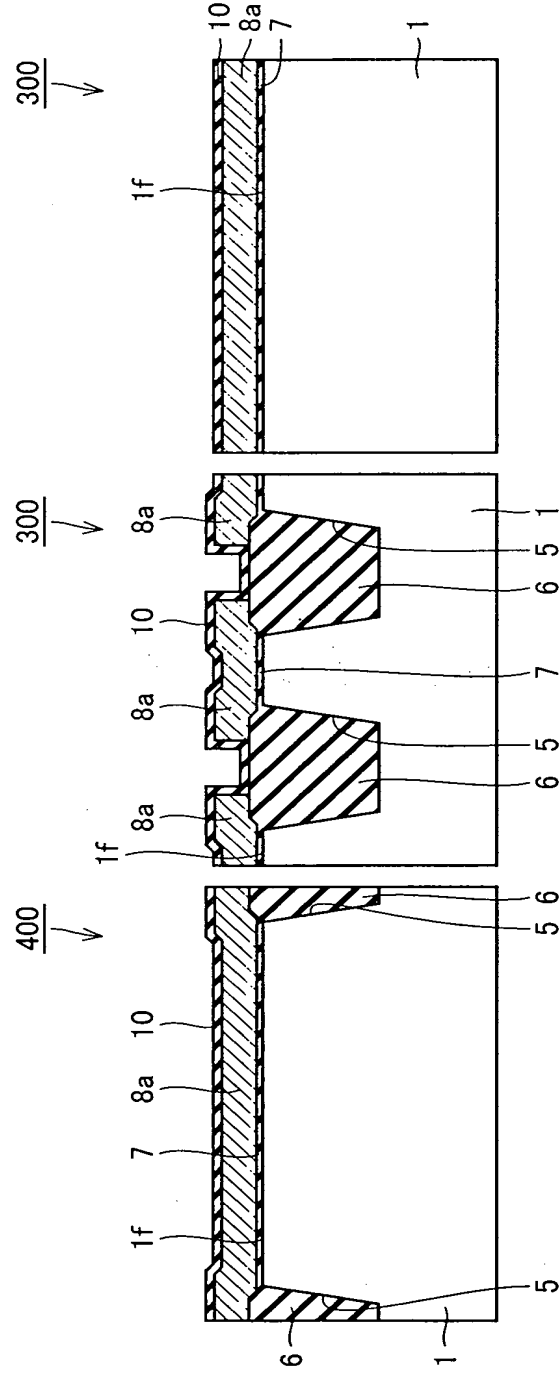


FIG.14A

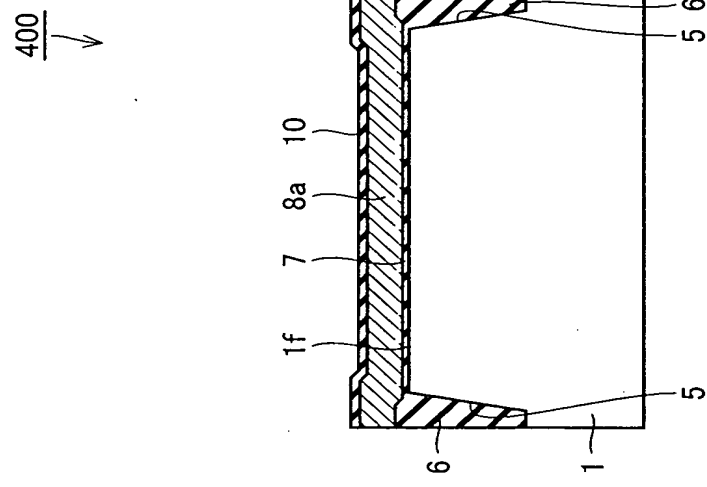


FIG.14B

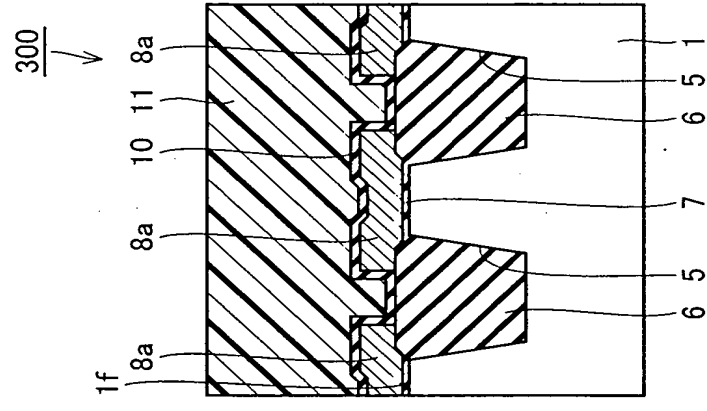


FIG.14C

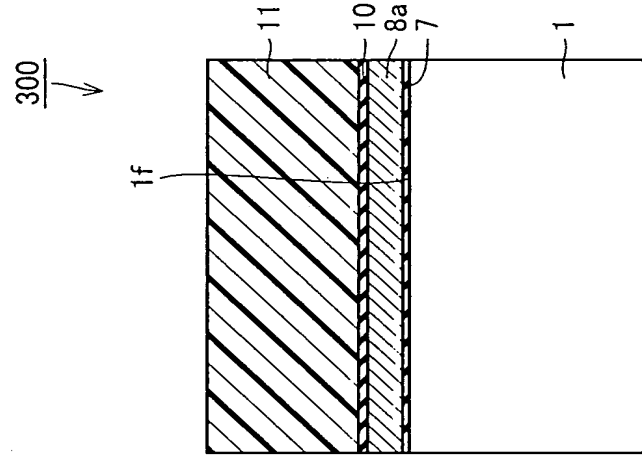


FIG.15A

FIG.15B

FIG.15C

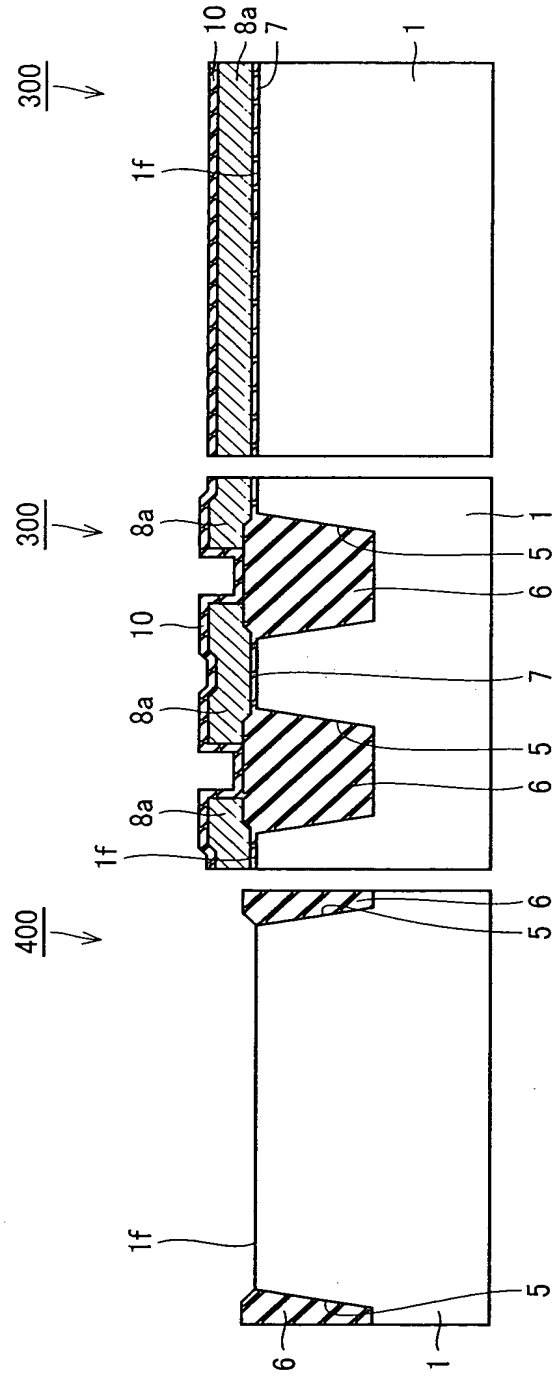


FIG.16A

400

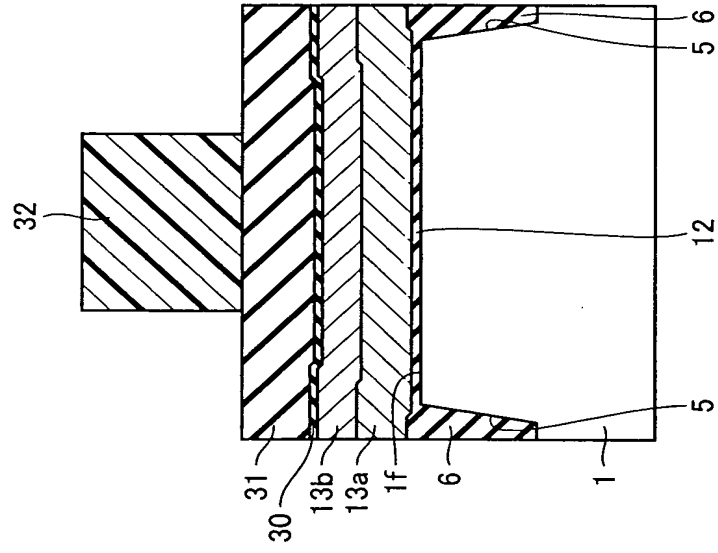
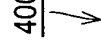


FIG.16B

300

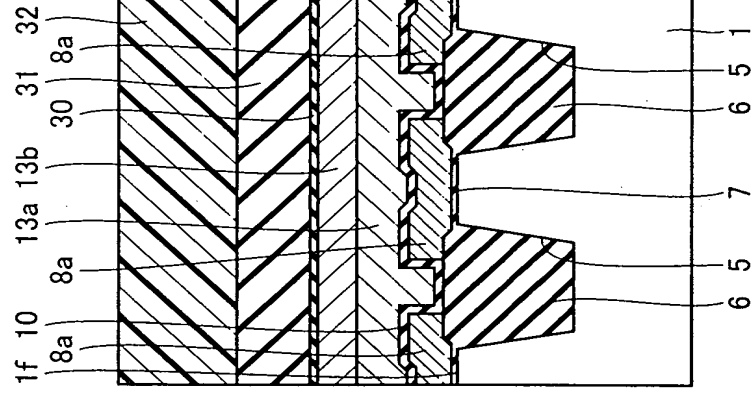
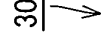


FIG.16C

300

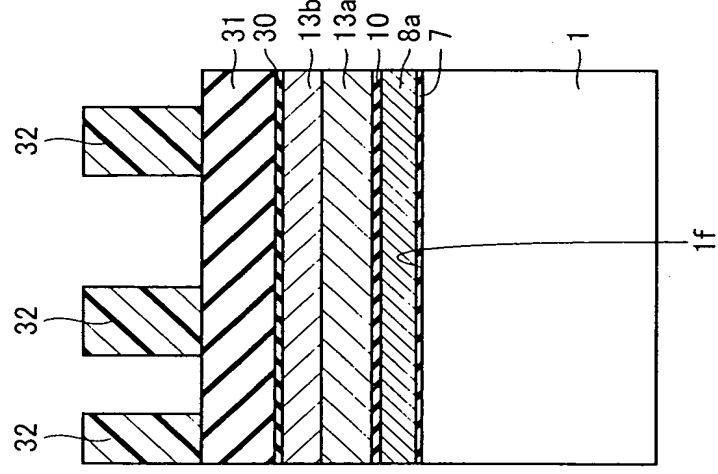
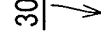
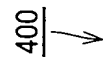
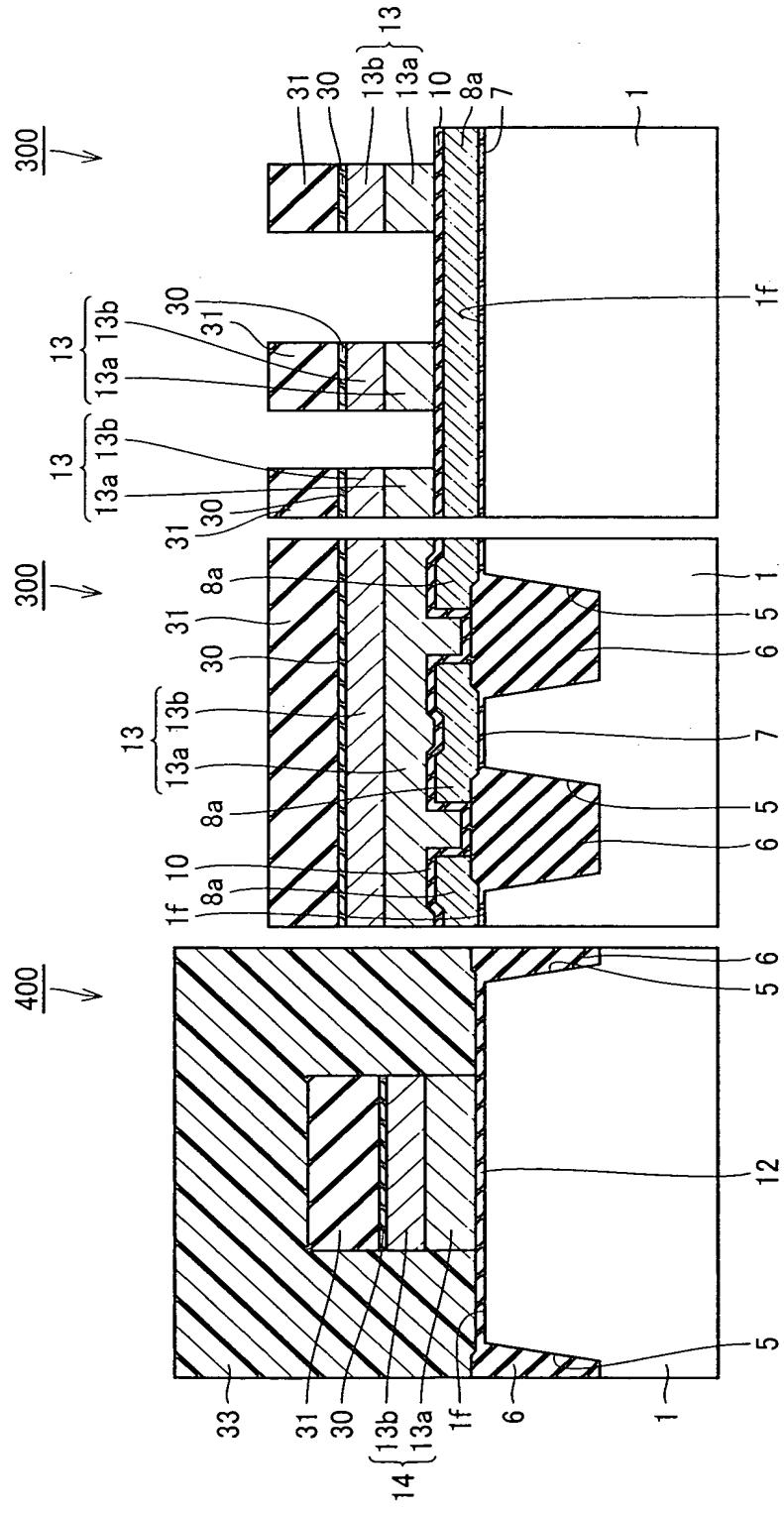


FIG. 17C





[illegible]

Figure 1 is a cross-sectional view of a semiconductor device. The device consists of a substrate 1 with a top layer 8. Below the top layer 8, there are several layers and structures labeled 1f, 10, 8, 30, 31, 13, 13a, 13b, 10, 143, and 1. The layers 13, 13a, and 13b are grouped together under the label 13. The layers 13a and 13b are further grouped under the label 13. The layers 13a and 13b are also labeled 13a and 13b respectively. The layers 13a and 13b are also labeled 13a and 13b respectively. The layers 13a and 13b are also labeled 13a and 13b respectively.

FIG. 20C

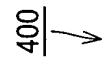


FIG.21A

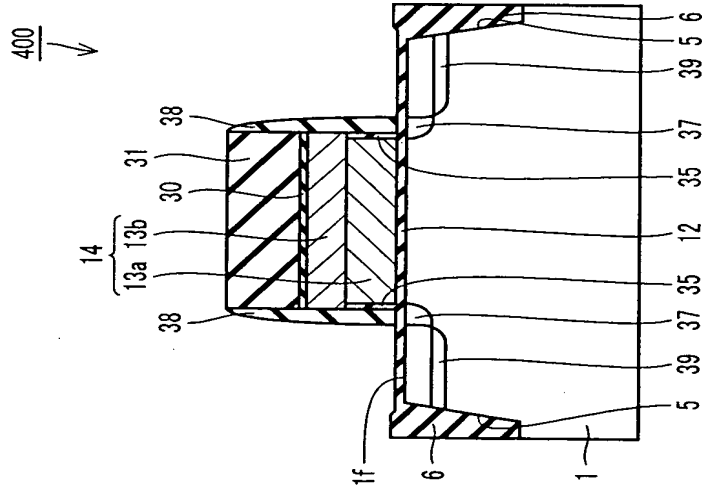


FIG.21B

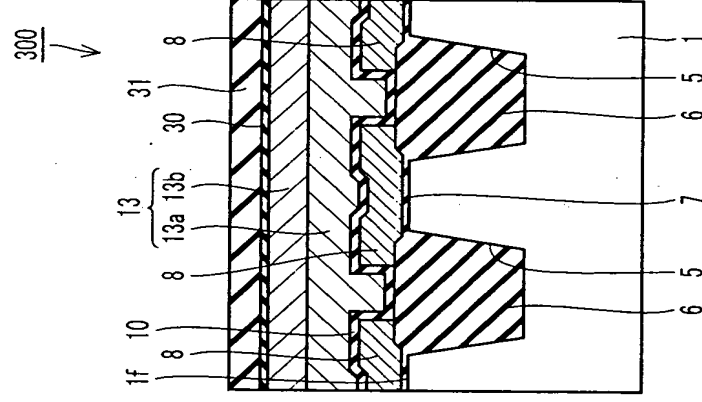


FIG.21C

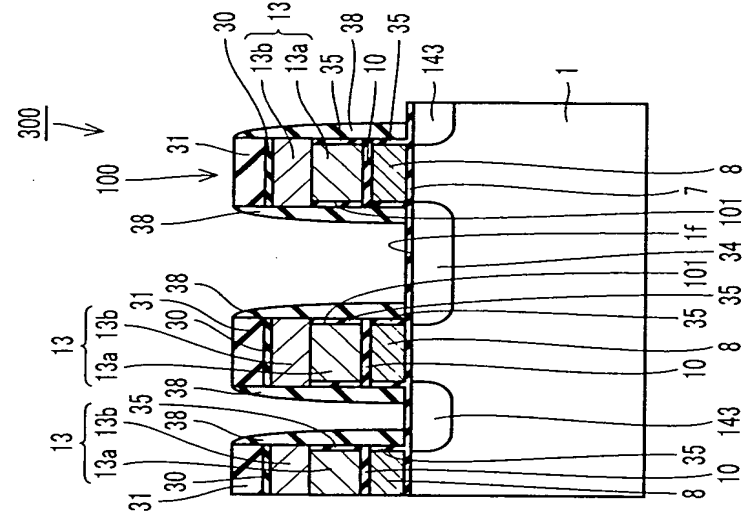


FIG.22A

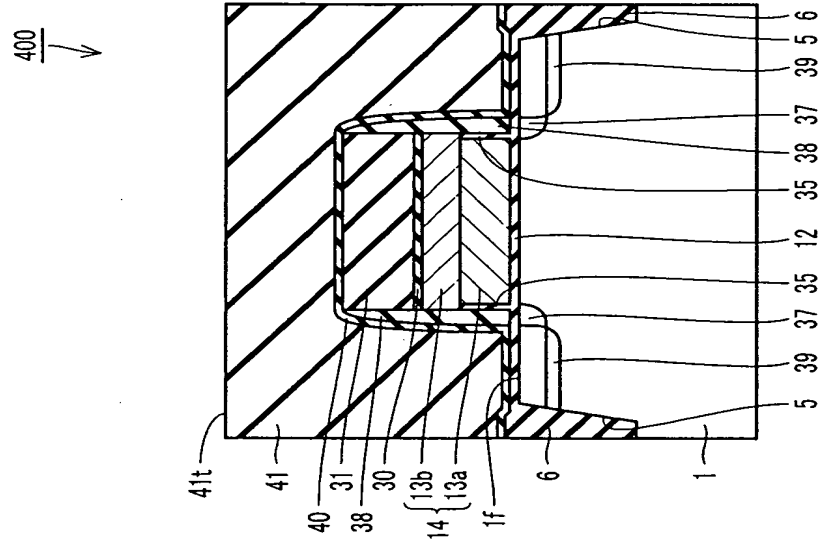


FIG.22B

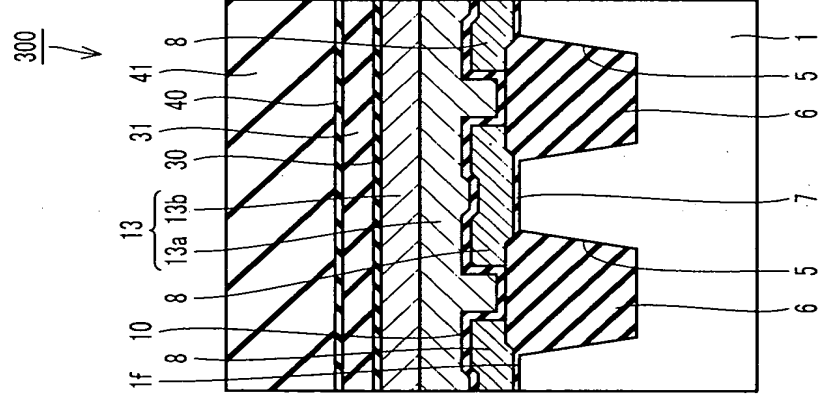


FIG.22C

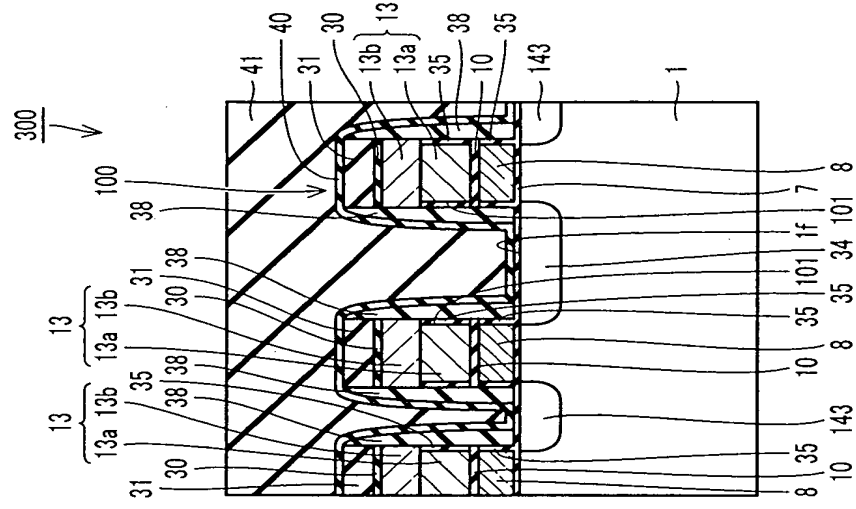


FIG.23A

400
↓

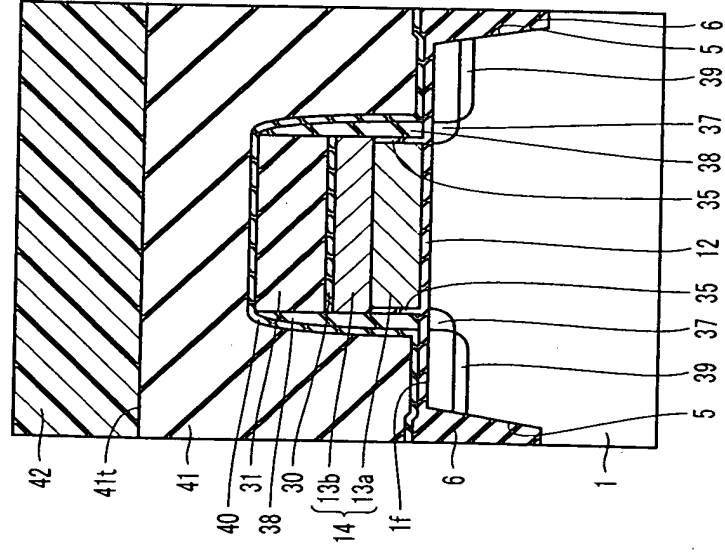


FIG.23B

300
↓

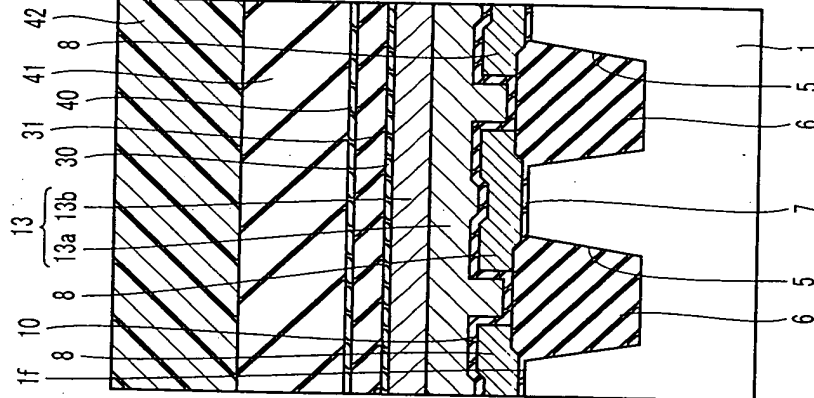


FIG.23C

300
↓

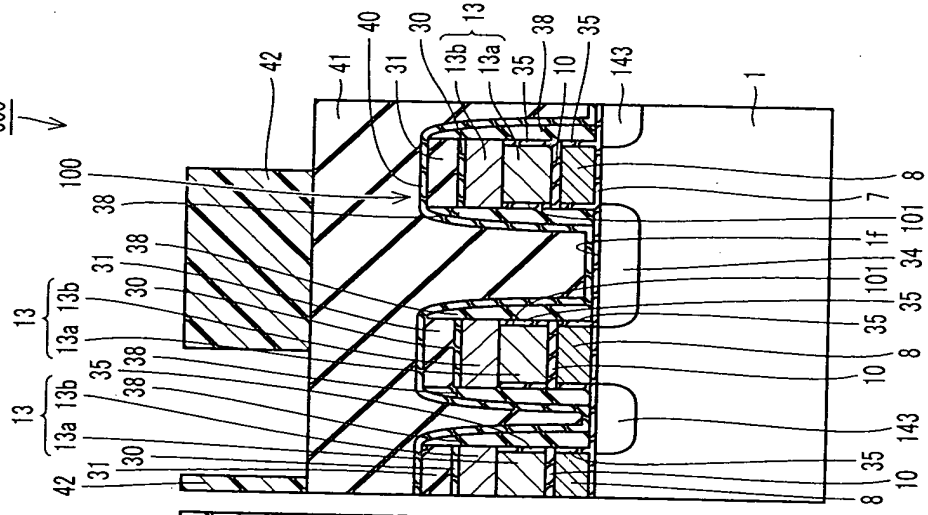


FIG.25A

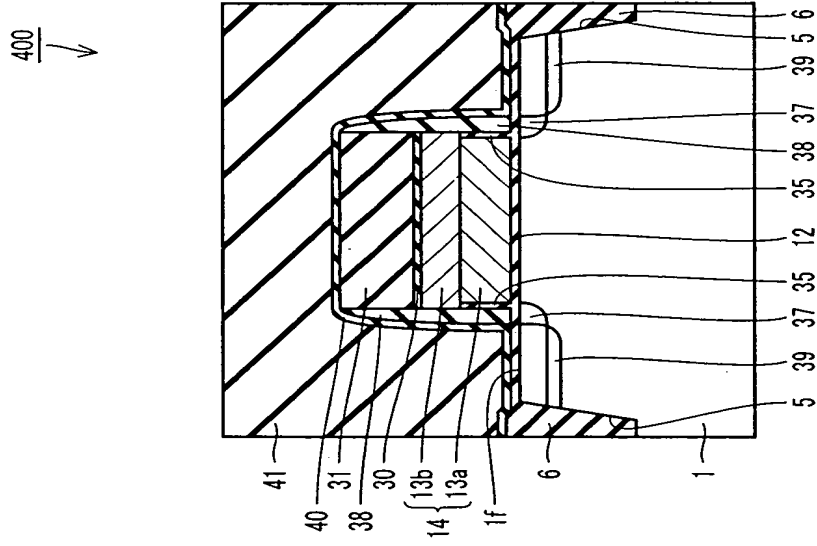


FIG.25B

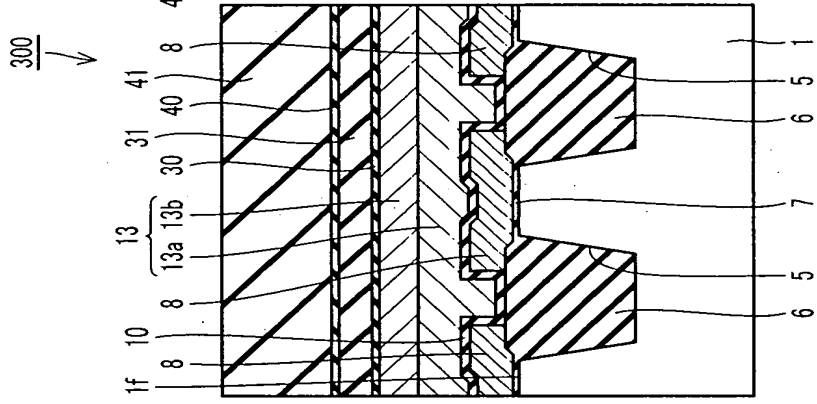


FIG.25C

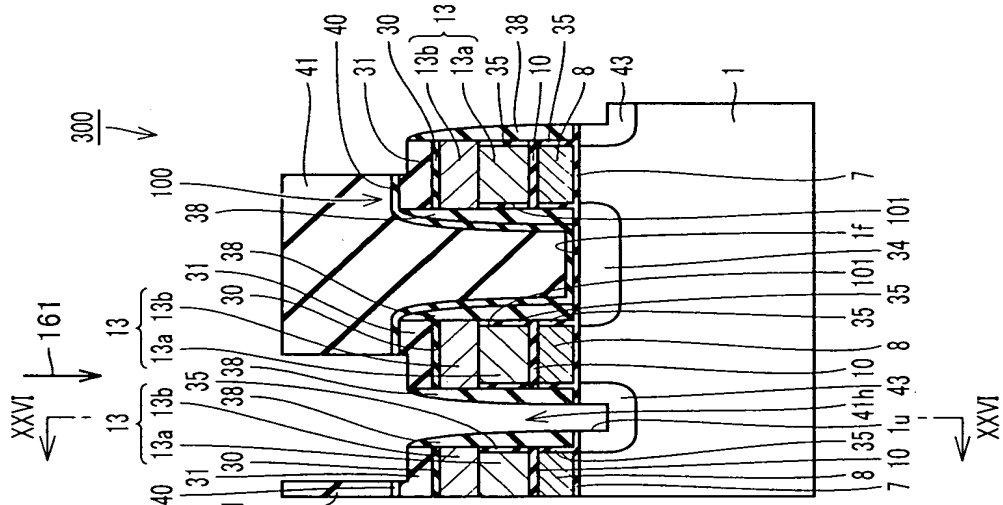


FIG.26

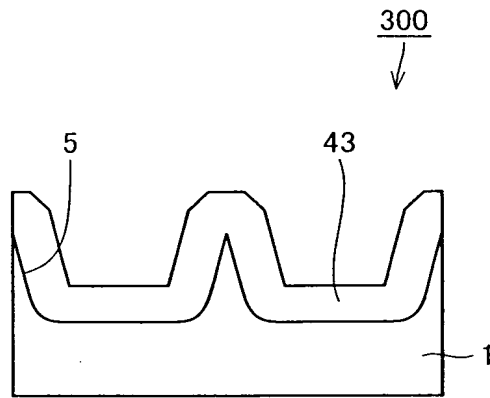


Fig. 6 is a cross-sectional view of a second embodiment of the device. It shows a similar assembly to Fig. 5, with a base 1, a support 6, and a central component 1f. The central component has a top surface 13a and a bottom surface 13b, which are part of a larger structure 14. Other components include 30, 31, 38, 40, 41, and 60. A scale bar at the bottom indicates a length of 400 units.

[illegible][illegible]

FIG. 31C

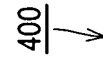


FIG. 32B

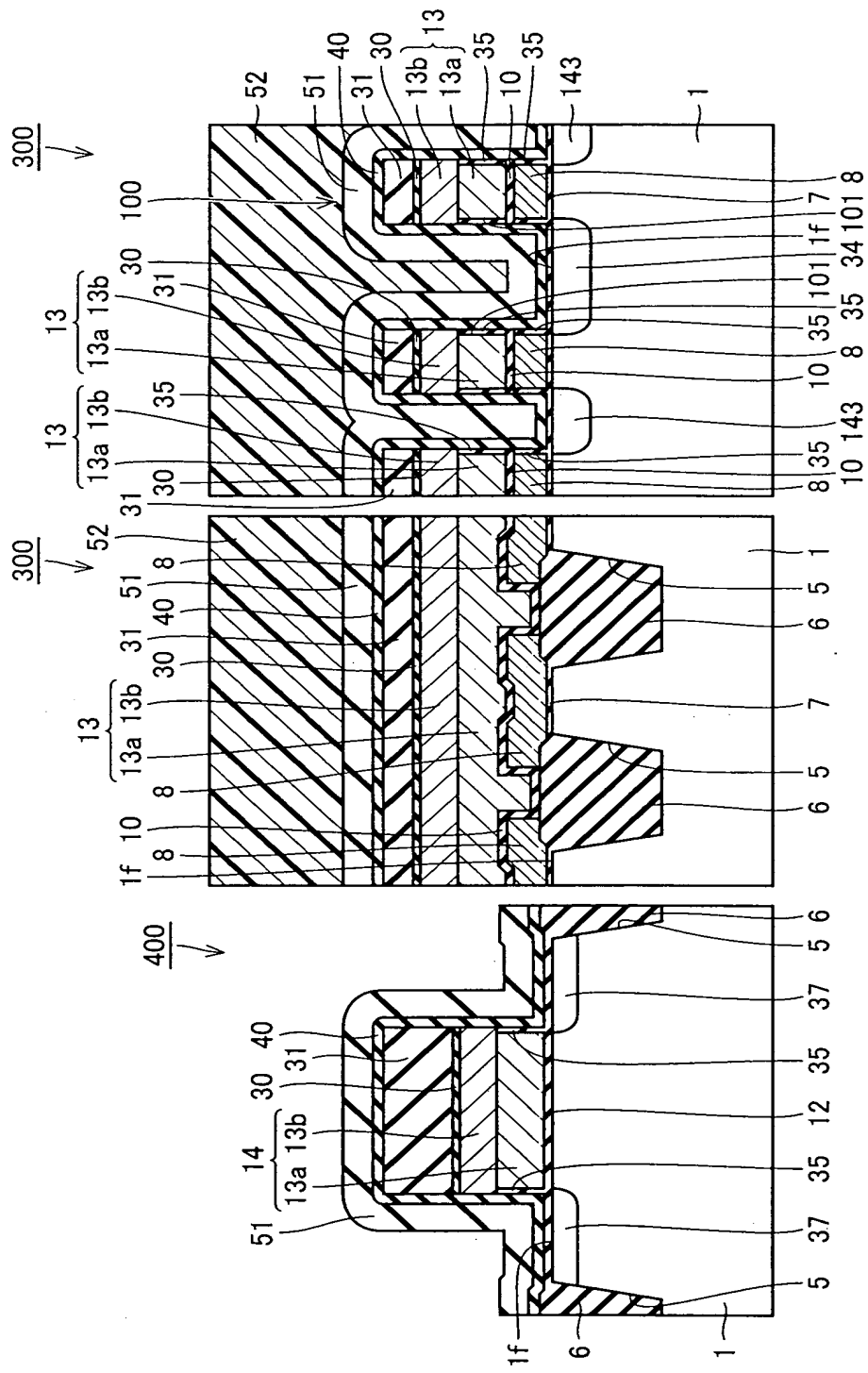


FIG.33A

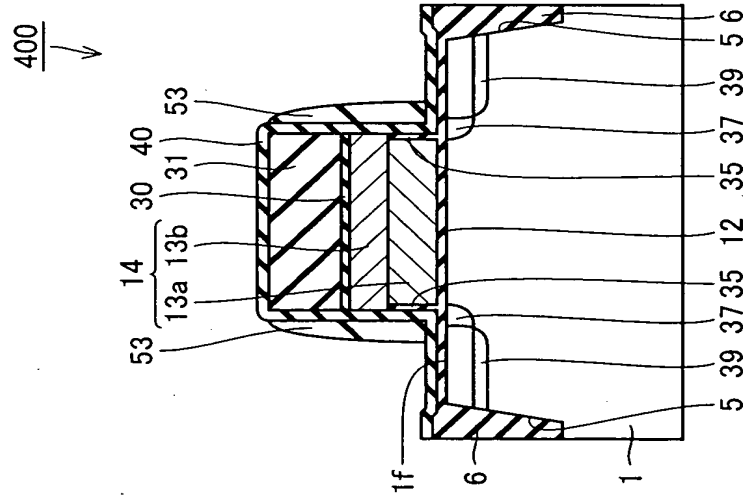


FIG.33B

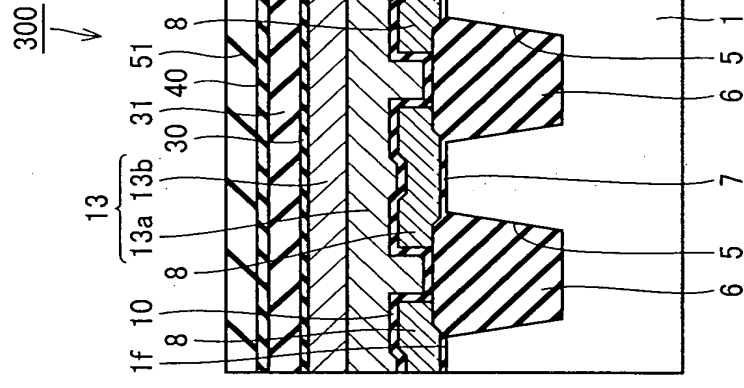
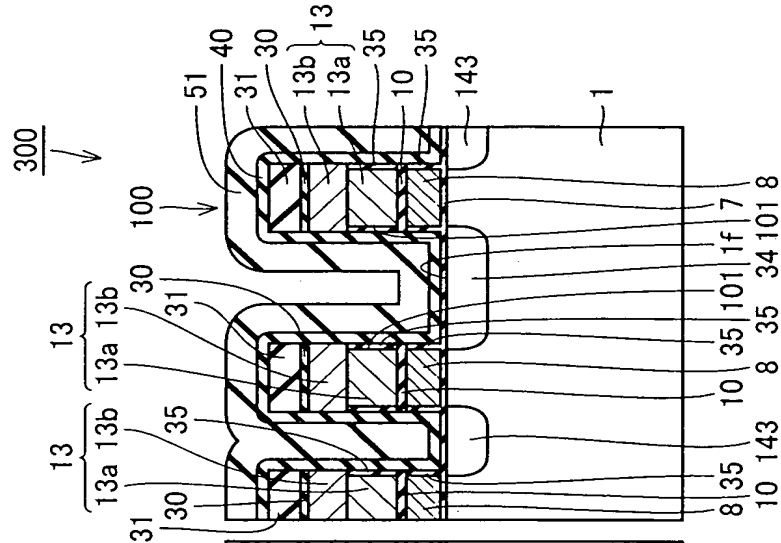


FIG.33C



A detailed cross-sectional view of a mechanical component, likely a housing or bracket, designated as Fig. 6. The part is shown in section with diagonal hatching. It features a complex internal profile with several recessed areas and protrusions. Key labeled components include: 1f (bottom flange), 13a and 13b (internal vertical surfaces), 14 (a horizontal ledge), 30 and 31 (inner wall sections), 37 and 39 (upper curved surfaces), 40 and 41 (top edge details). The overall shape suggests it is designed to fit around or support another part.

A cross-sectional view of a multi-layered structure 300. The structure consists of several layers: a top layer 4, a layer 51, a layer 8, a layer 10, a layer 8, a layer 1f, a layer 13, a layer 13a, a layer 13b, a layer 30, a layer 31, a layer 51, a layer 40, a layer 41, and a bottom layer 8. The layers 13, 13a, and 13b are grouped together. The structure is shown with various hatching patterns to indicate different materials or layers.

FIG.36

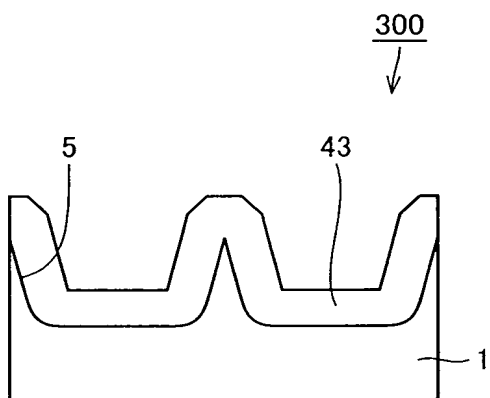


FIG.37A

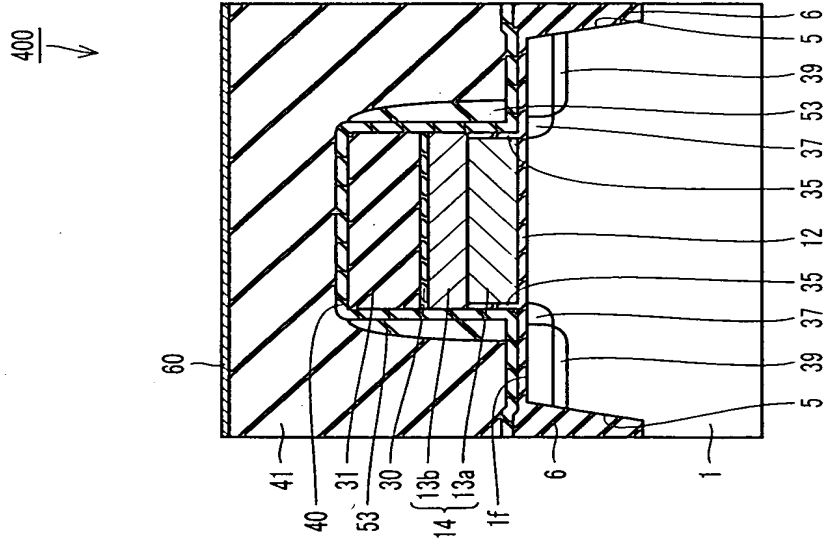


FIG.37B

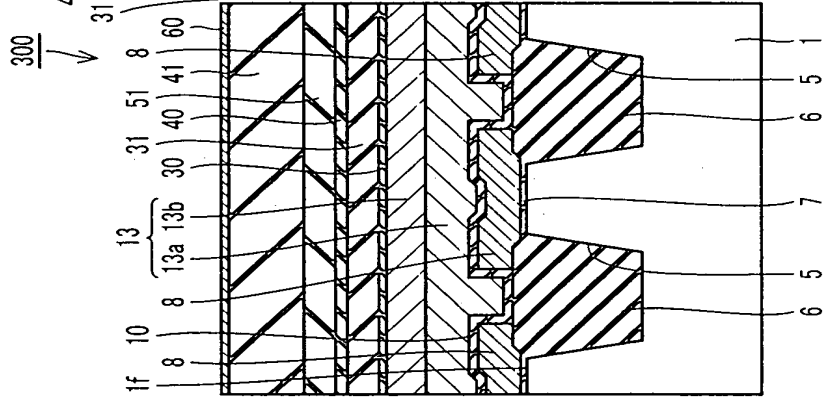
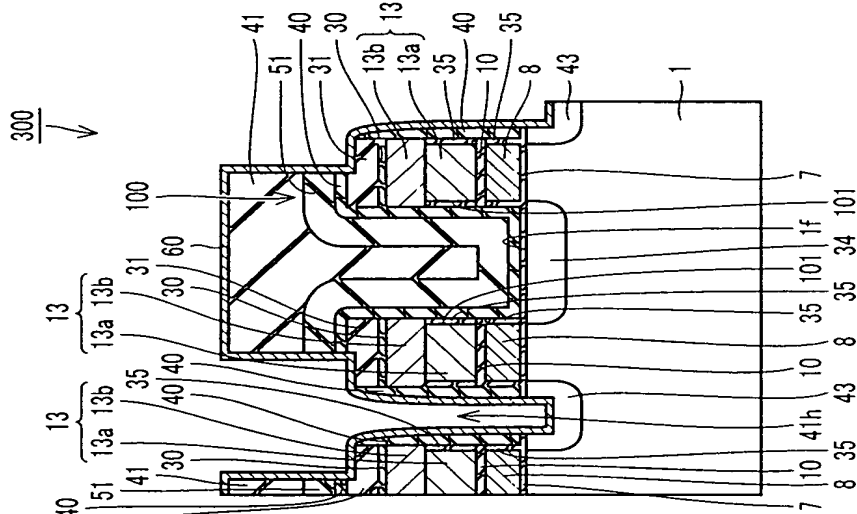


FIG.37C



[illegible]

FIG.40

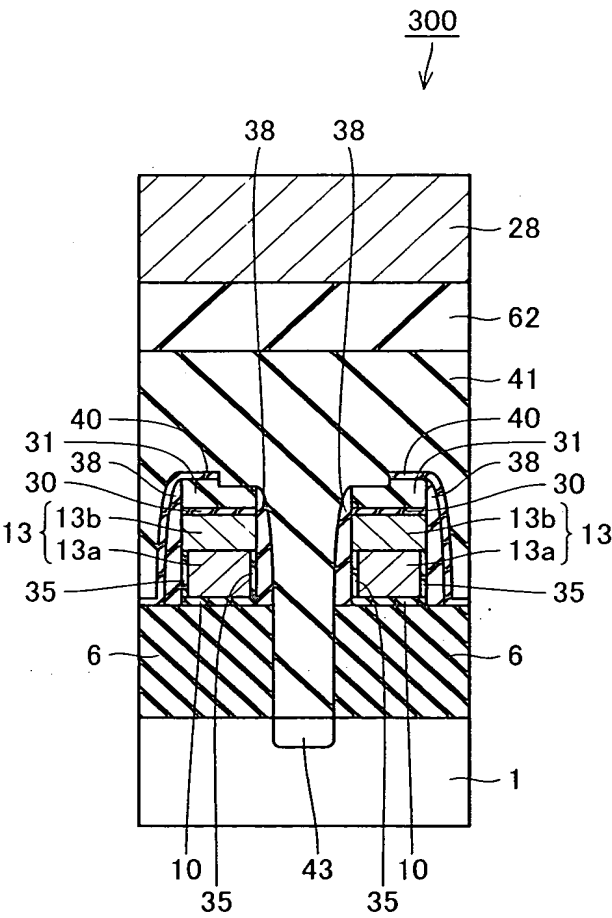
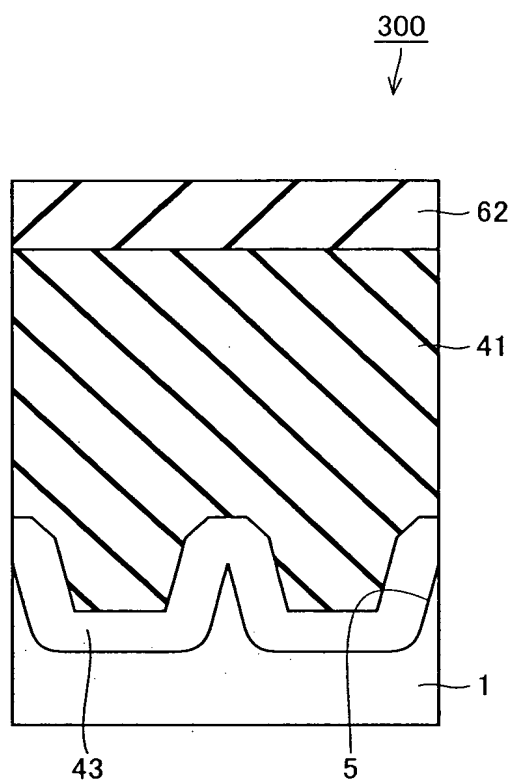


FIG.41



The figure consists of three vertical cross-sectional views of a mechanical assembly, labeled 300, 400, and 500 at the top. Each view shows a central shaft-like component with various internal features and surrounding housing parts.

- View 300:** Shows a central shaft with multiple steps or changes in diameter. Key components are labeled with numbers: 1 (outer housing), 6 (inner sleeve), 7 (seal/ring), 8 (bearing/housing part), 10 (shaft section), 13 (internal feature), 13a (sub-feature), 13b (sub-feature), 30 (internal cavity), 31 (internal wall), 40 (internal shoulder), 41 (internal step), 41a (sub-shoulder), 51 (internal ring), 62 (external flange), and 100 (top cap). Arrows indicate axial movement D1 and D2.
- View 400:** Similar to View 300, but with different internal dimensions and features. Labels include 1, 5, 6, 7, 8, 10, 1f, 13, 13a, 13b, 28, 41, 41a, 62, and 100. The internal profile of the shaft is modified compared to View 300.
- View 500:** Another variation of the assembly. Labels include 1, 5, 6, 7, 12, 35, 37, 39, 53, 56, 6, 14, 13a, 13b, 30, 31, 40, 41, 41a, 28, 62, and 100. This version includes additional features like 14 and 53.

The drawings use standard engineering conventions: hatching for different materials, solid lines for edges, and dashed lines for hidden internal features. The labels are placed around the drawings to identify specific parts and their variations across the three views.